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# MF3ICD(H)Q1

## MIFARE DESFire EV1 256B contactless smartcard IC

Rev. 3.0 — 5 November 2015 351330

Product short data sheet COMPANY PUBLIC

# 1. General description

MIFARE DESFire EV1 256B (MF3ICD(H)Q1), is the future proof entry level product of the well-established MIFARE DESFire family and is addressing applications with low memory but high security and data integrity needs.

The MIFARE DESFire EV1 256B offers the same security and file creation features as the higher memory family members (Ref. 1), but the number of applications and related files on this product is limited due to its small memory plot.

This addresses the needs of account based systems and environments requiring only a limited set of applications.

These applications include but are not limited to access management, public transport ticketing, loyalty schemes and closed-loop payment.

It is fully compatible to all other members of the MIFARE DESFire EV1 family, offering the same fast and highly secure data transmission, and is fully interoperable with existing MIFARE DESFire infrastructure.

All MIFARE DESFire products are based on open global standards for both air interface and implemented cryptographic methods. It is compliant to all 4 levels of ISO/IEC 14443A and uses optional ISO/IEC 7816-4 commands, features an on-chip backup management system and mutual three-pass authentication as well as encrypted communication.

The size of each file is defined at the moment of its creation, provides an automatic anti-tear mechanism for all file types, guaranteeing transaction-oriented data integrity. Data transfer rates from up to 848 Kbit/s can be achieved, allowing for fast data transmission.

The main characteristics of the MIFARE DESFire family are denoted by the name "DESFire": "DES" indicates the high level of security using a hardware crypto co-processor for either 3DES or AES-based data processing. "Fire" indicates its outstanding position as a fast, innovative and highly reliable IC ideally suited to enable a wide variety of different applications.



### 2. Features and benefits

# 2.1 RF interface: ISO/IEC 14443 Type A

- Contactless transmission of data and powered by the RF-field (no battery needed)
- Operating distance: up to 100 mm (depending on power provided by the PCD and antenna geometry)
- Operating frequency: 13.56 MHz
- Fast data transfer: 106 kbit/s, 212 kbit/s, 424 kbit/s, 848 kbit/s
- High data integrity: 16/32 bit CRC, parity, bit coding, bit counting
- True deterministic anticollision
- 7 bytes unique identifier (cascade level 2 according to ISO/IEC 14443-3 and option for random ID)
- Uses ISO/IEC 14443-4 protocol

## 2.2 ISO/IEC 7816 compatibility

- Supports ISO/IEC 7816-3 APDU message structure
- Supports ISO/IEC 7816-4 INS code 'A4' for SELECT FILE
- Supports ISO/IEC 7816-4 INS code 'B0' for READ BINARY
- Supports ISO/IEC 7816-4 INS code 'D6' for UPDATE BINARY
- Supports ISO/IEC 7816-4 INS code 'B2' for READ RECORDS
- Supports ISO/IEC 7816-4 INS code 'E2' for APPEND RECORD
- Supports ISO/IEC 7816-4 INS code '84' for GET CHALLENGE
- Supports ISO/IEC 7816-4 INS code '88' for INTERNAL AUTHENTICATE
- Supports ISO/IEC 7816-4 INS code '82' for EXTERNAL AUTHENTICATE

### 2.3 Non-volatile memory

- 256 bytes application memory<sup>1, 2</sup>
- Data retention of 10 years
- Write endurance typical 500 000 cycles

### 2.4 NV-memory organization

- Flexible file system
- Number of applications and files per application depending on available memory
- File types supported: standard data file, back-up data file, value file, linear record file and cyclic record file
- File size is determined during creation

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<sup>1.</sup> User application example: 1 Application, 2 AES keys, 1 Data file (256 bytes)

<sup>2.</sup> Also available in 2 KB, 4 KB and 8 KB. Refer to Ref. 1.

## 2.5 Security

- Based on the same Common Criteria EAL4+ certified MIFARE DESFire EV1 platform
- Unique 7 bytes serial number for each device
- Optional "RANDOM" ID for enhance security and privacy
- Mutual three-pass authentication
- Mutual authentication according to ISO/IEC 7816-4
- 1 card master key and up to 14 keys per application
- Hardware DES using 56/112/168 bit keys featuring key version, data authenticity by 8 byte CMAC
- Hardware AES using 128-bit keys featuring key version, data authenticity by 8 byte CMAC
- Data encryption on RF-channel
- Authentication on application level
- Hardware exception sensors
- Self-securing file system
- Backward compatibility to MF3ICD40: 4 byte MAC, CRC 16

## 2.6 Special features

- Transaction-oriented automatic anti-tear mechanism
- Configurable ATS information for card personalization
- Backward compatibility mode to MF3ICD40
- Optional high input capacitance (70 pF) for small form factor design (MF3ICDHQ1)

# 3. Applications

- Public transport ticketing: Account based or Single Journey ticketing
- High secure access management
- Hospitality
- Event ticketing
- Loyalty
- Gift cards
- Smart Visitor Badges (SVB)

# 4. Quick reference data

Table 1. Quick reference data [1][2]

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f <sub>i</sub>	input frequency			-	13.56	-	MHz
Ci	input capacitance	MF3ICDQ1	[3][4]	14.96	17.0	19.04	pF
		MF3ICDHQ1	[3][4]	64.00	69.0	74.00	рF
EEPROM cl	naracteristics	,	"	'	<u>'</u>	,	
t <sub>ret</sub>	retention time	T <sub>amb</sub> = 22 °C		10	-	-	year
N <sub>endu(W)</sub>	write endurance	T <sub>amb</sub> = 22 °C		200000	500000	-	cycle
t <sub>cy(W)</sub>	write cycle time	T <sub>amb</sub> = 22 °C		-	2.9	-	ms

<sup>[1]</sup> Stresses above one or more of the values may cause permanent damage to the device.

# 5. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
MF3ICDQ101DUD/06	FFC	8 inch wafer (sawn; 120 μm thickness, on film	-		
		frame carrier; electronic fail die marking			
		according to SECSII format); see Ref. 4, 256B EEPROM, 17 pF			
MF3ICDHQ101DUD/06	FFC	8 inch wafer (sawn; 120 μm thickness, on film	-		
		frame carrier; electronic fail die marking			
		according to SECSII format); see Ref. 4, 256B EEPROM, 70 pF			
MF3ICDQ101DUF/06	FFC	8 inch wafer (sawn; 75 μm thickness, on film	-		
		frame carrier; electronic fail die marking			
		according to SECSII format); see Ref. 4, 256B EEPROM, 17 pF			
MF3ICDHQ101DUF/06	FFC	8 inch wafer (sawn; 75 μm thickness, on film	-		
		frame carrier; electronic fail die marking			
		according to SECSII format); see Ref. 4, 256B EEPROM, 70 pF			
MF3MODQ101DA8/06	PLLMC[1]	plastic leadless module carrier package; 35 mm	SOT500-4		
		wide tape; see Ref. 5, 256B EEPROM, 17 pF			
MF3MODHQ101DA8/06	PLLMC[1]	plastic leadless module carrier package; 35 mm	SOT500-4		
		wide tape; see Ref. 5, 256B EEPROM, 70 pF			

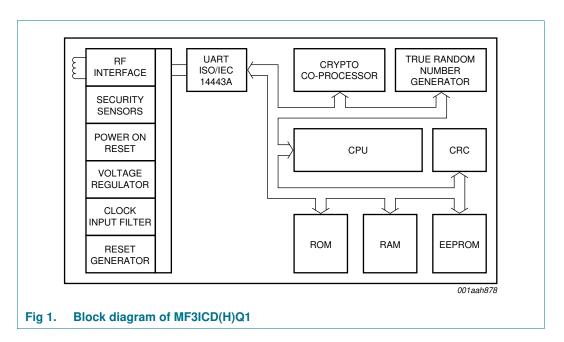
<sup>[1]</sup> This package is also known as MOA8.

<sup>[2]</sup> Exposure to limiting values for extended periods may affect device reliability.

<sup>[3]</sup> Measured with LCR meter.

<sup>[4]</sup>  $T_{amb} = 22 \,^{\circ}\text{C}$ ;  $f_i = 13.56 \,\text{MHz}$ ; 2.8 V RMS

# 6. Block diagram



# 7. Limiting values

Table 3. Limiting values [1][2]

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
l <sub>l</sub>	input current			-	30	mA
P <sub>tot</sub> /pack	total power dissipation per package			-	200	mW
T <sub>stg</sub>	storage temperature			-55	125	°C
T <sub>amb</sub>	ambient temperature			-25	70	°C
V <sub>ESD</sub>	electrostatic discharge voltage		[3]	2	-	kV
I <sub>lu</sub>	latch-up current			±100	-	mA

- [1] Stresses above one or more of the limiting values may cause permanent damage to the device.
- [2] Exposure to limiting values for extended periods may affect device reliability.
- [3] MIL Standard 883-C method 3015; human body model: C = 100 pF, R = 1.5 k $\Omega$ .

# 8. Functional description

### 8.1 Contactless energy and data transfer

In the MIFARE system, the MIFARE DESFire EV1 is connected to a coil consisting of a few turns embedded in a standard ISO/IEC smart card (see Ref. 7). A battery is not needed. When the card is positioned in the proximity of the PCD antenna, the high-speed RF communication interface allows data to be transmitted up to 848 kbit/s.

#### 8.2 Anti-collision

An intelligent anti-collision mechanism allows more than one MIFARE DESFire EV1 in the field to be handled simultaneously. The anti-collision algorithm selects each MIFARE DESFire EV1 individually and ensures that the execution of a transaction with a selected MIFARE DESFire EV1 is performed correctly without data corruption resulting from other MIFARE DESFire EV1s in the field.

#### 8.3 UID/serial number

The unique 7 byte (UID) is programmed into a locked part of the NV memory which is reserved for the manufacturer. Due to security and system requirements these bytes are write-protected after being programmed by the IC manufacturer at production time. According to ISO/IEC 14443-3 (see Ref. 11) during the first anti-collision loop the cascade tag returns a value of 88h and also the first 3 bytes of the UID, UID0 to UID2 and BCC. The second anti-collision loop returns bytes UID3 to UID6 and BCC.

UID0 holds the manufacturer ID for NXP (04h) according to ISO/IEC 14443-3 and ISO/IEC 7816-6 AMD 1.

MIFARE DESFire EV1 also allows Random ID to be used. In this case MIFARE DESFire EV1 only uses a single anti-collision loop. The 3 byte random number is generated after RF reset of the MIFARE DESFire EV1.

## 8.4 Memory organization

MF3ICD(H)Q1 has 480 bytes of physical NV memory. The NV memory is organized using a flexible file system. This file system allows a limited number of different applications on one MIFARE DESFire EV1. Each application can have multiple files. Every application is represented by its 3 bytes Application IDentifier (AID).

Five different file types are supported; see Section 8.5.

A guideline to assign DESFire AIDs can be found in the application note *MIFARE Application Directory* (MAD); see <u>Ref. 8</u>.

Each file can be created either at MIFARE DESFire EV1 initialization (card production/card printing), at MIFARE DESFire EV1 personalization (vending machine) or in the field.

If a file or application becomes obsolete in operation, it can be permanently invalidated.

Commands which have impact on the file structure itself (e.g. creation or deletion of applications, change of keys) activate an automatic rollback mechanism, which protects the file structure from being corrupted.

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If this rollback is necessary, it is done without user interaction before carrying out further commands. To ensure data integrity on application level, a transaction-oriented backup is implemented for all file types with backup. It is possible to mix file types with and without backup within one application.

As the commands are the same with MF3ICD81, the command details are available in Ref. 1. Only the memory size is different between the devices.

### 8.5 Available file types

The files within an application can be any of the following types:

- Standard data files
- · Backup data files
- Value files with backup
- · Linear record files with backup
- Cyclic record files with backup

### 8.6 Security

The 7 byte UID is fixed, programmed into each device during production. It cannot be altered and ensures the uniqueness of each device.

The UID may be used to derive diversified keys for each ticket. Diversified MIFARE DESFire EV1 keys contribute to gain an effective anti-cloning mechanism and increase the security of the original key; see Ref. 6.

Prior to data transmission a mutual three-pass authentication can be done between MIFARE DESFire EV1 and PCD depending on the configuration employing either 56-bit DES (single DES, DES), 112-bit DES (triple DES, 3DES), 168-bit DES (3 key triple DES, 3K3DES) or AES. During the authentication, the level of security of all further commands during the session is set. In addition, the communication settings of the file/application result in the following options of secure communication between MIFARE DESFire EV1 and PCD:

- Plain data transfer (only possible within the backwards-compatible mode to MF3ICD40)
- Plain data transfer with cryptographic checksum (MAC): Authentication with backwards-compatible mode to MF3ICD40: 4 byte MAC, all other authentications based on DES/3DES/AES: 8 byte CMAC
- Encrypted data transfer (secured by CRC before encryption): Authentication with backwards-compatible mode to MF3ICD40: A 16-bit CRC is calculated over the stream and attached. The resulting stream is encrypted using the chosen cryptographic method. All other authentications-based DES/3DES/AES: A 32-bit CRC is calculated over the stream and attached. The resulting stream is encrypted using the chosen cryptographic method.

Find more information on the security concept of the product in <u>Ref. 1</u>. Be aware not all levels of security are recommended. The recommended secure handling of the product can be seen in <u>Ref. 2</u> and in <u>Ref. 10</u>.

### 8.7 Product identification

The MF3ICD(H)Q1 can be identified by using the Get Version command and observing the response frames as following:

The first frame: contains hardware-related information:

byte 1: 0x04

byte 2: 0x01

byte 3: 0x01 for 17 pF or 0x02 for 70 pF

byte 4: 0x01

byte 5: 0x00

byte 6: 0x10

byte 7: 0x05

The second frame contains software-related information:

byte 1: 0x04

byte 2: 0x01

byte 3: 0x01

byte 4: 0x01

byte 5: 0x05

byte 6: 0x10

byte 7: 0x05

# 9. DESFire command set

A detailed description of all commands is provided in Ref. 1.

## 9.1 ISO/IEC 14443-3

Table 4. ISO/IEC 14443-3

Command	Description
REQA	REQA and ATQA are implemented fully according to ISO/IEC 14443-3
WUPA	WUPA is implemented fully according to ISO/IEC 14443-3
ANTICOLLISION/SELECT Cascade Level 1	ANTICOLLISION and SELECT commands are implemented fully according to ISO/IEC 14443-3; the response is part 1 of the UID
ANTICOLLISION/SELECT Cascade Level 2	ANTICOLLISION and SELECT commands are implemented fully according to ISO/IEC 14443-3; the response is part 2 of the UID
HALT	brings MIFARE DESFire EV1 to the HALT state

# 9.2 ISO/IEC 14443-4

Table 5. ISO/IEC 14443-4

Command	Description
RATS	identifies the MIFARE DESFire EV1 type to the PCD
PPS	allows individual selection of the communication baud rate between PCD and MIFARE DESFire EV1; for DESFire it is possible to set different communication baud rates for each direction i.e. DESFire allows a non-symmetrical information interchange speed.
WTX	if the MIFARE DESFire EV1 needs more time than the defined FWT to respond to a PCD command it requests a Waiting Time eXtension (WTX)
DESELECT	allows MIFARE DESFire EV1 to be brought to the HALT state

# 9.3 MIFARE DESFire EV1 command set overview – security related commands

Table 6. Security related commands

Command	Description
Authenticate	MIFARE DESFire EV1 and the reader device show in an encrypted way that they possess the same secret which especially means the same key; this not only confirms that both entities are permitted to perform operations on each other but also creates a session key which can be used to keep the further communication path secure; as the name "session key" implicitly indicates, each time a new authentication procedure is successfully completed a new key for further cryptographic operations is generated
Change KeySettings	changes the master key settings on MIFARE DESFire EV1 and application level
Set Configuration	configures the card and pre-personalizes the card with a key, defines if the UID or the random ID is sent back during communication setup and configures the ATS string
Change Key	changes any key stored on the MIFARE DESFire EV1
Get Key Version	reads out the current key version of any key stored on the MIFARE DESFire EV1

**Remark:** All command and data frames are exchanged between MIFARE DESFire EV1 and PCD by using block format as defined in ISO/IEC 14443-4.

# 9.4 MIFARE DESFire EV1 command set overview – MIFARE DESFire EV1 level commands

Table 7. Level commands

Command	Description
Create Application	creates new applications on the MIFARE DESFire EV1
Delete Application	permanently deactivates applications on the MIFARE DESFire EV1
Get Applications IDs	returns the Application IDentifiers of all applications on a MIFARE DESFire EV1
Free Memory	returns the free memory available on the card
GetDFNames	returns the DF names
Get KeySettings	gets information on the MIFARE DESFire EV1 and application master key settings; in addition it returns the maximum number of keys which are configured for the selected application
Select Application	selects one specific application for further access
FormatPICC	releases the MF3ICD(H)Q1 user memory
Get Version	returns manufacturing related data of the MIFARE DESFire EV1
GetCardUID	returns the UID

**Remark:** All command and data frames are exchanged between MIFARE DESFire EV1 and PCD by using block format as defined in ISO/IEC 14443-4.

# 9.5 MIFARE DESFire EV1 command set overview – application level commands

Table 8. Application level commands

Command	Description
Get FileIDs	returns the File IDentifiers of all active files within the currently selected application
Get FileSettings	gets information on the properties of a specific file
Change FileSettings	changes the access parameters of an existing file
Create StdDataFile	creates files for the storage of plain unformatted user data within an existing application on the MIFARE DESFire EV1
Create BackupDataFile	creates files for the storage of plain unformatted user data within an existing application on the MIFARE DESFire EV1, additionally supporting the feature of an integrated backup mechanism
Create ValueFile	creates files for the storage and manipulation of 32-bit signed integer values within an existing application on the MIFARE DESFire EV1
Create LinearRecordFile	creates files for multiple storage of similar structural data, for example, loyalty programs within an existing application on the MIFARE DESFire EV1; once the file is filled completely with data records, further writing to the file is not possible unless it is cleared
Create CyclicRecordFile	creates files for multiple storage of similar structural data, for example, logging transactions within an existing application on the MIFARE DESFire EV1; once the file is filled completely with data records, the MIFARE DESFire EV1 automatically overwrites the oldest record with the latest written one (this wrap is fully transparent for the PCD)
DeleteFile	permanently deactivates a file within the file directory of the currently selected application

**Remark:** All command and data frames are exchanged between MIFARE DESFire EV1 and PCD by using block format as defined in ISO/IEC 14443-4.

# 9.6 MIFARE DESFire EV1 command set overview – data manipulation commands

Table 9. Data manipulation commands

Command	Description		
Read Data	reads data from Standard Data files or Backup Data files		
Write Data	writes data to Standard Data files or Backup Data files		
Get Value	reads the currently stored value from Value files		
Credit	increases a value stored in a Value file		
Debit decreases a value stored in a Value file			
Limited Credit	allows a limited increase of a value stored in a Value file without having full Credit permissions to the file		
Write Record	writes data to a record in a Cyclic or Linear Record file		
Read Records	reads out a set of complete records from a Cyclic or Linear Record file		

 Table 9.
 Data manipulation commands ...continued

Command	Description
Clear RecordFile	resets a Cyclic or Linear Record file to empty state
Commit Transaction	validates all previous write accesses on Backup Data files, Value files and Record files within one application
Abort Transaction	invalidates all previous write accesses on Backup Data files, Value files and Record files within one application

**Remark:** All command and data frames are exchanged between MIFARE DESFire EV1 and PCD by using block format as defined in ISO/IEC 14443-4.

#### 9.7 MIFARE DESFire EV1 command set - ISO/IEC 7816 APDU commands

The MIFARE DESFire EV1 provides the following commands according to ISO/IEC 7816-4:

- INS code 'A4' SELECT
- INS code 'B0' READ BINARY
- INS code 'D6' UPDATE BINARY
- INS code 'B2' READ RECORDS
- INS code 'E2' APPEND RECORD
- INS code '84' GET CHALLENGE
- INS code '88' INTERNAL AUTHENTICATE
- INS code '82' EXTERNAL AUTHENTICATE

## 9.7.1 ISO/IEC 7816-4 APDU message structure

DESFire supports the APDU message structure according to ISO/IEC 7816-4 for:

- an optional wrapping of the native DESFire APDU format
- additionally implemented ISO/IEC 7816-4 commands

Find more information on the ISO/IEC 7816-4 commands in Ref. 1.

# 10. Abbreviations

Table 10. Abbreviations

Acronym	Description	
AES	Advanced Encryption Standard	
AID	Application IDentifier	
APDU	Application Protocol Data Unit	
ATS	Answer to Select	
CC	Common Criteria	
CMAC	Cryptic Message Authentication Code	
CRC	Cyclic Redundancy Check	
DES	Digital Encryption Standard	
DF	Dedicated File	
EAL	Evaluation Assurance Level	
EEPROM	Electrically Erasable Programmable Read-Only Memory	
FWT	Frame Waiting Time	
ID	IDentifier	
INS	Instructions	
LCR	inductance, Capacitance, Resistance	
MAC	Message Authentication Code	
MAD	MIFARE Application Directory	
NV	Non-Volatile Memory	
PCD	Proximity Coupling Device	
PPS	Protocol Parameter Selection	
RATS	Request Answer To Select	
REQA	Request Answer	
RF	Radio Frequency	
UID	Unique IDentifier	
WTX	Waiting Time eXtension	
WUPA	Wake Up Protocol A	

## 11. References

- [1] Data sheet MF3ICD81 MIFARE DESFire EV1 Functional Specification, document number: 13403\*\*3.
- [2] Data sheet MF3ICD81 Guidance, Delivery and Operation Manual, document number: 1469\*\*.
- [3] Data sheet Specification addendum MF3ICD81, document number: 1673\*\*.
- [4] Data sheet MF3ICD8101 Sawn bumped 120 μm wafer addendum, document number: 1318\*\*.
- [5] Data sheet MF3MOD81 Contactless chip card module, document number: 1439\*\*.
- **[6]** Application note MIFARE DESFire Implementation hints and examples, document number: 0945\*\*.
- [7] Application note Card Coil Design Notes for MIFARE DESFire EV1, document number: 1713\*\*.
- [8] Application note MIFARE Application Directory, document number: 0018\*\*.
- [9] Application note MIFARE ISO/IEC 14443 PICC Selection, document number: 1308\*\*.
- [10] Application note End to end system security risk considerations for implementing contactless cards, document number: 1550\*\*.
- [11] ISO/IEC Standard ISO/IEC 14443 Identification cards Contactless integrated circuit cards Proximity cards.



# 12. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
MF3ICDQ1_MF3ICDHQ1_ SDS	20151105	Product short data sheet	-	-

# 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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